

# **10A, 100V Trench Schottky Surface Mount Rectifier**

### FEATURES

- Excellent high temperature stability
- Low forward voltage
- Lower power loss/ high efficiency
- High forward surge capability
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converter

### **MECHANICAL DATA**

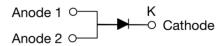
- Case: TO-277A (SMPC4.6U)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.104g (approximately)

KEY PARAMETERS			
VALUE	UNIT		
10	А		
100	V		
395	А		
150	°C		
TO-277A (SMPC4.6U)			
Single die			
	VALUE   10   100   395   150   TO-277A (SMI)		





TO-277A (SMPC4.6U)



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)			
PARAMETER	SYMBOL	TSUP10102	UNIT
Marking code on the device		UP10102	
Repetitive peak reverse voltage	V <sub>RRM</sub>	100	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	70	V
Forward current	lF	10	А
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I <sub>FSM</sub>	395	А
Junction temperature	TJ	- 55 to +150	°C
Storage temperature	T <sub>STG</sub>	- 55 to +150	°C





THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-lead thermal resistance <sup>(1)</sup>	Rejl	2	°C/W	
Junction-to-ambient thermal resistance <sup>(2)</sup>	Reja	46	°C/W	
Junction-to-case thermal resistance <sup>(2)</sup>	Rejc	6	°C/W	

### **Thermal Performance Notes:**

1. With ideal heat sink

2. Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage <sup>(1)</sup>	I <sub>F</sub> = 5A, T <sub>J</sub> = 25°C	VF	0.60	-	V
	$I_F = 10A, T_J = 25^{\circ}C$		0.69	0.72	V
	I <sub>F</sub> = 5A, T <sub>J</sub> = 125°C		0.50	-	V
	I <sub>F</sub> = 10A, T <sub>J</sub> = 125°C		0.59	0.62	V
Reverse current @ rated $V_R^{(2)}$	T <sub>J</sub> = 25°C	IR	-	15	μA
	T <sub>J</sub> = 125°C		-	10	mA
Junction capacitance	1MHz, V <sub>R</sub> = 4.0V	CJ	887	-	pF

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
TSUP10102	TO-277A (SMPC4.6U)	6,000 / Tape & Reel	



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

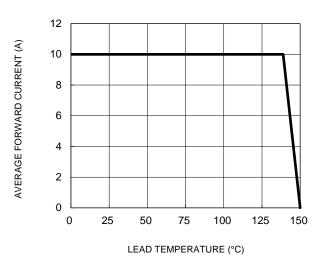


Fig.1 Forward Current Derating Curve

**Fig.3 Typical Reverse Characteristics** 

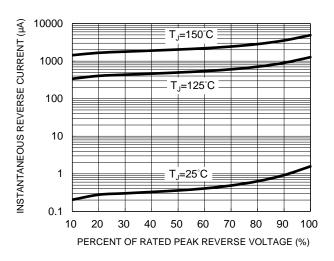
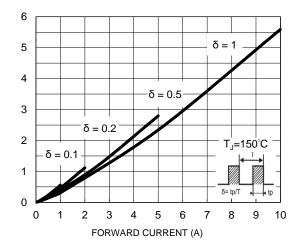


Fig.5 Typical Forward Power Dissipation vs. Forward Current



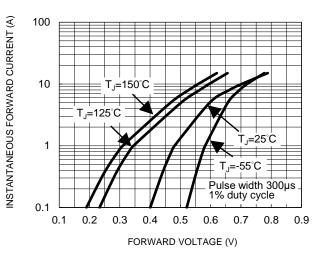
POWER DISSIPATION (W)

(1000) (10

**Fig.2 Typical Junction Capacitance** 

#### REVERSE VOLTAGE (V)

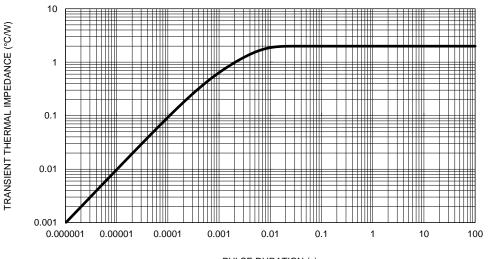
**Fig.4 Typical Forward Characteristics** 





### **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

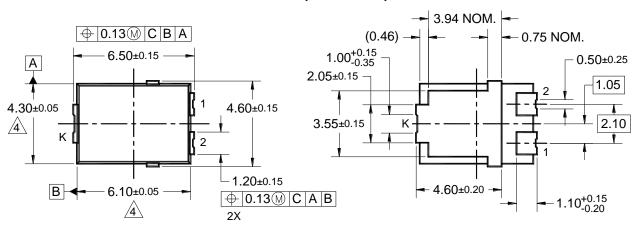


**Fig.6 Typical Transient Thermal Characteristics** 

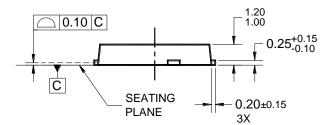
PULSE DURATION (s)

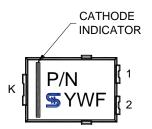


### PACKAGE OUTLINE DIMENSIONS



#### TO-277A(SMPC4.6U)

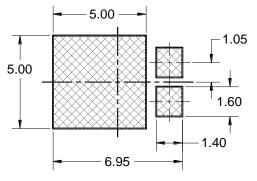




#### MARKING DIAGRAM

P/N	=	MARKING CODE

F = FACTORY CODE



SUGGESTED PAD LAYOUT

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-277 ISSUE A.
- 4 MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD LASH, PROTRUSIONS OR GATE BURRS.
- 5. DWG NO. REF: HQ2SD07-SMPC4.6U-031 REV A.



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